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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/643,526	08/22/2000	Tongbi Jiang	303.705US1	9708	
7.	590 06/19/2002				
Schwegman, Lundberg, Woessner & Kluth, P.A.			EXAMINER		
Attn: Danny I Padys	UNG S				
Minneapolis, M	1N 55402			PAPER NUMBER	
			2841		
DATE MAILED: 06/19/2002			}		

Please find below and/or attached an Office communication concerning this application or proceeding.

<u> </u>			
	Application No.	Applicant(s)	,
	09/643,526	JIANG ET AL.	
Office Action Summary	Examiner	Art Unit	<del>_</del> _
	Hung S Bui	2841	
The MAILING DATE of this communication a Period for Reply	appears on the cover sheet with th	e correspondence address	; <b></b>
A SHORTENED STATUTORY PERIOD FOR REI THE MAILING DATE OF THIS COMMUNICATIOI  - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a  - If NO period for reply is specified above, the maximum statutory peri  - Failure to reply within the set or extended period for reply will, by sta  - Any reply received by the Office later than three months after the may earned patent term adjustment. See 37 CFR 1.704(b).  Status	N. t 1.136(a). In no event, however, may a reply b reply within the statutory minimum of thirty (30) iod will apply and will expire SIX (6) MONTHS t atute. cause the application to become ABANDO	e timely filed  days will be considered timely.  rom the mailing date of this communi  DNED (35 U.S.C. § 133).	cation.
1) Responsive to communication(s) filed on _	·		
2a) This action is <b>FINAL</b> . 2b)⊠	This action is non-final.		
3) Since this application is in condition for allo closed in accordance with the practice und	owance except for formal matters ler <i>Ex parte Quayle</i> , 1935 C.D. 1	, prosecution as to the me 1, 453 O.G. 213.	rits is
Disposition of Claims	<b></b>		
4)⊠ Claim(s) 1-44 is/are pending in the applicat			
4a) Of the above claim(s) <u>26-44</u> is/are withd	rawn from consideration.		
5) Claim(s) is/are allowed.			
6)⊠ Claim(s) <u>1-25</u> is/are rejected.			
7) Claim(s) is/are objected to.			
8) Claim(s) are subject to restriction and	d/or election requirement.		
Application Papers	iner		
<ul><li>9)  The specification is objected to by the Exam</li><li>10)  The drawing(s) filed on is/are: a)  ac</li></ul>		- - - -	ζ
Applicant may not request that any objection to			
11) The proposed drawing correction filed on			
If approved, corrected drawings are required in		p. 0 . 0	
12) The oath or declaration is objected to by the			
Priority under 35 U.S.C. §§ 119 and 120			
13) Acknowledgment is made of a claim for fore	eign priority under 35 U.S.C. § 11	9(a)-(d) or (f).	
a) ☐ All b) ☐ Some * c) ☐ None of:	sign phoney and or or or or s	(4)	
1.☐ Certified copies of the priority docume	ents have been received		
2. Certified copies of the priority documents		cation No	
			e
<ul><li>3. Copies of the certified copies of the paper application from the International</li><li>* See the attached detailed Office action for a</li></ul>	Bureau (PCT Rule 17.2(a)).		
14) Acknowledgment is made of a claim for dome	estic priority under 35 U.S.C. § 1	19(e) (to a provisional appl	ication).
<ul> <li>a)  The translation of the foreign language</li> <li>15)  Acknowledgment is made of a claim for dom</li> </ul>			
Attachment(s)			
<ol> <li>Notice of References Cited (PTO-892)</li> <li>Notice of Draftsperson's Patent Drawing Review (PTO-948)</li> <li>Information Disclosure Statement(s) (PTO-1449) Paper Note</li> </ol>	5) Notice of Inform	mary (PTO-413) Paper No(s) nal Patent Application (PTO-152	

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### **DETAILED ACTION**

#### Election/Restrictions

1. Claims 26-34 are withdrawn from further consideration pursuant to 37 CFR 1.142(b) as being drawn to a nonelected claimed invention, there being no allowable generic or linking claim. Election was made without traverse in Paper No. 7.

## Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claims 1-7 and 10-12 are rejected under 35 U.S.C. 103(a) as being unpatentable over Benzinger et al. [US 3,617,613] in view of Beck [US 2,695,351].

Regarding claims 1-2 and 4, Benzinger et al. disclose a circuit board (2) comprising:

- a core layer (6) having one or more fibers (see column 3, lines 35-37); and
- a surface layer (7) having a surface layer thickness between about 10 and 30% of the circuit board thickness (see figure 2).

Benzinger et al. disclose the instant claimed invention except for the surface layer being free of fibers.

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Beck discloses a multilayer circuit board (10) having a surface layer (11) formed of a resinous material free of fibers (see figure 13).

It would have been obvious to a person having ordinary skill in the art at the time invention was made to use the non fiber material for the surface layer of Benzinger et al., as suggested by Beck, for the purpose of facilitating application of circuit traces on the board.

Regarding claim 3, Benzinger et al. disclose the use of non-woven glass fiber (see column 1, lines 57-65).

Regarding claim 5, Benzinger et al. disclose the use of resin in the core material (see column 2, lines 5-10).

Regarding claim 6, Benzinger et al. disclose the instant claimed invention except for the specific thickness of the core layer.

The specific thickness of the core layer would have an obvious design consideration based on the amount of reinforcement necessary for the printed circuit board.

Regarding claims 7 and 10-11, Benzinger et al. disclose the circuit board having first and second resin layers (5, 7), each of which having a thickness between 10 and 15 percents of the board thickness (see figure 1), surrounding a fibrous core layer (6).

Benzinger et al. disclose the instant claimed invention except for the first layer being free fibers.

Beck discloses a multilayer circuit board (10) having a surface layer (11) formed of a resinous material free of fibers (see figure 13).

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It would have been obvious to a person having ordinary skill in the art at the time invention was made to use the non fiber material for the surface layer of Benzinger et al., as suggested by Beck, for the purpose of facilitating application of circuit traces on the board.

Regarding claim 12, Benzinger et al. disclose the instant claimed invention except for the second layer being free of fibers.

Beck discloses first and second layers (11, 58) being mounted on a circuit board both of which being free of fibers.

It would have been obvious to a person having ordinary skill in the art at the time invention was made to use multiple non-fibrous materials for the first and second layers to improve the insulative quality of the surface of the printed circuit board.

4. Claims 8 and 9 are rejected under 35 U.S.C. 103(a) as being unpatentable over Benzinger et al., as modified, as applied to claim 7 above, and further in view of Carroll et al. [US 4,886,699].

Regarding claims 8-9, Benzinger et al., as modified, disclose the instant claimed invention except for the core having a greater mechanical strength than that of the first and second layers.

Carroll et al. disclose a circuit board having a core layer (18) having a greater mechanical strength than surrounding layers (14 and 16, see column 3, lines 55-65).

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It would have been obvious to a person having ordinary skill in the art at the time invention was made to use a core having a greater strength than the surrounding layers for the purpose of providing rigidity to the circuit board.

5. Claims 13-18 and 21-25 are rejected under 35 U.S.C. 103(a) as being unpatentable over the applicant admitted prior art shown in a figure 1 (AAPA, hereinafter) in view of Benzinger et al.

Regarding claims 13 and 16, AAPA discloses a circuit board assembly (see figure 1) including:

- a first circuit board (105);
- a second circuit board (103) coupled to the first circuit board; and
- a die coupled to the second circuit board.

AAPA discloses the instant claimed invention except for the specific design of the second circuit board.

Benzinger et al.disclose a multiple layer circuit board (2) having a fibrous core with fibers having a diameter in the arrange of 0.2 to 14 microns (see abstract lines 5-6) and the surface portion (7) located at a distance between about 10 to 20 percents of the thickness away from the number of fibers.

It would have been obvious to a person having ordinary skill in the art at the time invention was made to use the circuit board design of Benzinger et al. for the second circuit board of AAPA, for the purpose of facilitating mounting of the die.

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Regarding claims 14-15 and 17-18, AAPA discloses the instant claimed invention except for the specific type of die mounted on the second circuit board.

The specific type of die would have been an obvious design consideration based on the intended application for the circuit board assembly.

Regarding claims 21 and 24, AAPA discloses the instant claimed invention except for the specific design of the second circuit board.

Benzinger et al.disclose a multiple layer circuit board (2) having a fibrous core with fibers having a diameter in the arrange of 0.2 to 14 microns (see abstract lines 5-6) and the surface portion (7) located at a distance between about 10 to 20 percent of the thickness away from the number of fibers.

It would have been obvious to a person having ordinary skill in the art at the time invention was made to use the circuit board design of Benzinger et al. for the second circuit board of AAPA, for the purpose of facilitating mounting of the die.

Regarding claims 22-23, AAPA, as modified, disclose the instant claimed invention except for the specific types of circuit board used for the first and second circuit boards.

The specific types of circuit boards used for the first and second circuit boards would have an obvious design consideration based on the intended application for the circuit board assembly.

Regarding claim 25, AAPA discloses the use of an adhesive (112) securing the die to the second circuit board.

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6. Claims 19-20 are rejected under 35 U.S.C. 103(a) as being unpatentable over AAPA in view of Benzinger et al. as applied to claim 13 above and further in view of Beck.

Regarding claims 19-20, AAPA, as modified, disclose the instant claimed invention except for the surface layer of the second circuit board being free of fibers.

Beck discloses a multilayer circuit board (10) having a surface layer (11) formed of a resinous material free of fibers (see figure 13).

It would have been obvious to a person having ordinary skill in the art at the time invention was made to use the non fiber material for the surface layer of AAPA in view of Benzinger et al., as suggested by Beck, for the purpose of facilitating application of circuit traces on the board.

#### Conclusion

7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Hung S Bui whose telephone number is (703) 305-8024. The examiner can normally be reached on Monday-Friday 8:30AM-6:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, David S. Martin can be reached on (703) 308-3121. The fax phone numbers for the organization where this application or proceeding is assigned are (703)

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308-7722 for regular communications and (703) 308-7724 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 305-0956.

HB 6/14/02

DAVID MARTIN
SUPERVISORY PATENT EXAMINER
TECHNOLOGY CENTER 2800

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